# SiSS73DN

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Top View

**PRODUCT SUMMARY** 

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 10 V

V<sub>DS</sub> (V)

 $I_D(A)$ 

Q<sub>g</sub> typ. (nC)

Configuration

PowerPAK® 1212-8S

D

S G

Bottom View

-150

0.125

14.6

-16.2 <sup>a</sup>

Single

**Vishay Siliconix** 

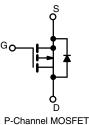
## P-Channel 150 V (D-S) MOSFET

## **FEATURES**

- TrenchFET<sup>®</sup> with ThunderFET technology
- Very low R<sub>DS(on)</sub> minimizes power loss from conduction
- 100 % R<sub>q</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Active clamp
- · Battery and circuit protection
- Motor drive control
- · Load switch



ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS73DN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-150	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		-16.2		
	T <sub>C</sub> = 70 °C	1 . 🗖	-12.9		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-4.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	-3.5 <sup>b, c</sup>	A	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-30		
	T <sub>C</sub> = 25 °C		-16.2		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	Is	-4.1 <sup>b, c</sup>		
Single pulse avalanche current L = 0.1 mH		I <sub>AS</sub>	-20		
Single pulse avalanche energy		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		65.8		
Maximum power dissipation	T <sub>C</sub> = 70 °C		42.1	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5.1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	3.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) <sup>c</sup>			260	-0	

#### THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	C/ W

#### Notes

a.  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed d. copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 65 °C/W

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HALOGEN

FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, $I_D$ = -250 $\mu$ A	-150	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -10 mA	-	-200	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	6.4	-	mv/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-2	-	-4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
7	I <sub>DSS</sub>	$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current		$V_{DS}$ = -150 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	-15	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ -10 V, $V_{GS}$ = -10 V	-10	-	-	Α
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	0.100	0.125	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -10 A	-	8	-	S
Dynamic <sup>b</sup>	· ·					
Input capacitance	C <sub>iss</sub>		-	719	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -75 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	148	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	7	-	-
Table de aleman		$V_{DS} = -75 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	14.6	22	
Total gate charge	Qg		-	11.3	17	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -75 V, $V_{GS}$ = -7.5 V, $I_{D}$ = -10 A	-	4.8	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	4.5	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = -75 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	29.3	44	
Gate resistance	R <sub>q</sub>	f = 1 MHz	1	2.6	4.5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	
Rise time	t <sub>r</sub>	$V_{DD} = -75 \text{ V}, \text{ R}_{L} = 7.5 \Omega, \text{ I}_{D} \cong -10 \text{ A},$	-	6	12	- ns
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	18	36	
Fall time	t <sub>f</sub>		-	6	12	-
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-16.2	A
Pulse diode forward current	I <sub>SM</sub>		-	-	-30	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -5 A, V <sub>GS</sub> = 0 V	-	-0.83	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	62	125	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs,	-	180	360	nC
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	54	-	
Reverse recovery rise time	t <sub>b</sub>		-	8	-	ns

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

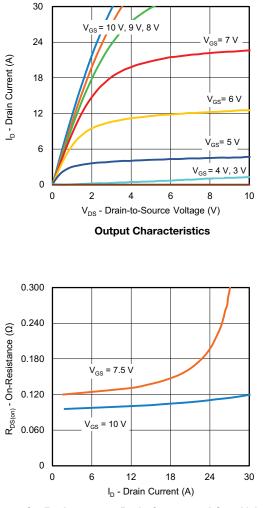
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

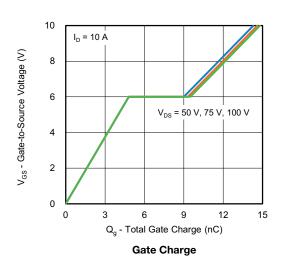
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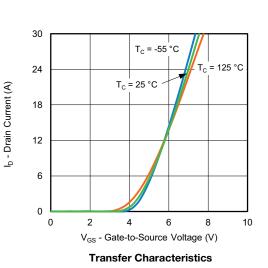


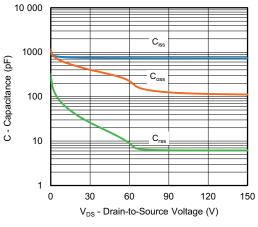
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



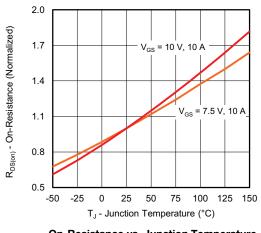
**On-Resistance vs. Drain Current and Gate Voltage** 











**On-Resistance vs. Junction Temperature** 

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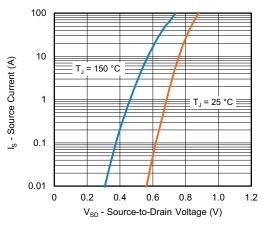
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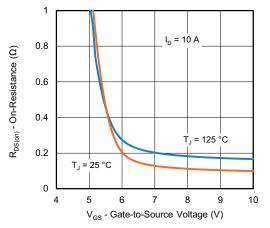
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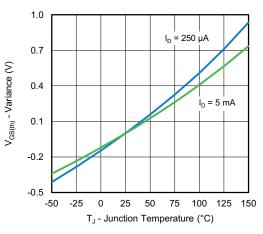
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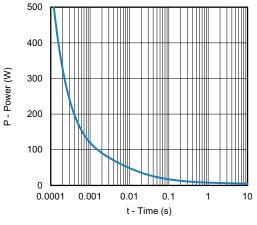
Source-Drain Diode Forward Voltage



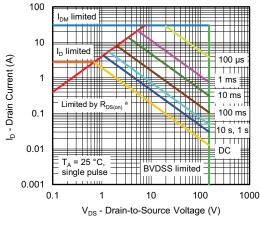
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

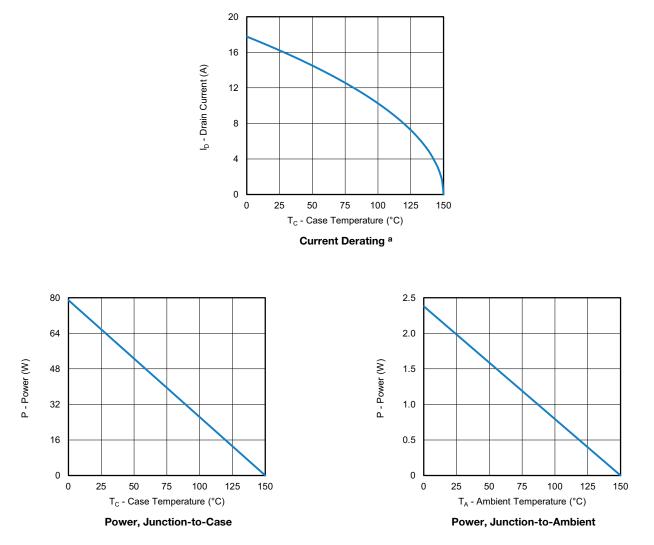
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Note

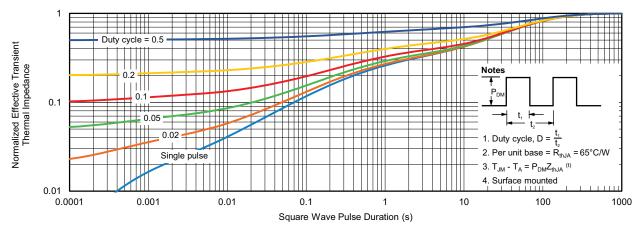
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



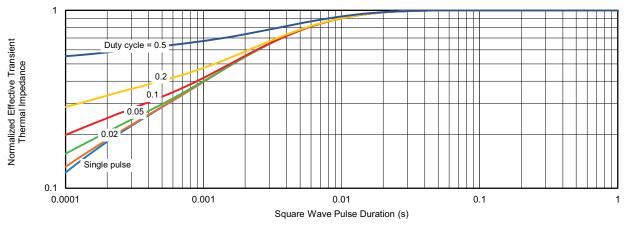
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

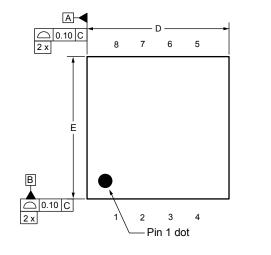


Normalized Thermal Transient Impedance, Junction-to-Case

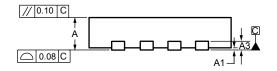
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# Case Outline for PowerPAK<sup>®</sup> 1212-8S







DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.67	0.75	0.83	0.026	0.030	0.033		
A1	0.00	-	0.05	0.000	-	0.002		
A3		0.20 ref.			0.008 ref			
b	0.25	0.30	0.35	0.010	0.012	0.014		
D	3.20	3.30	3.40	0.126	0.130	0.134		
D1	2.15	2.25	2.35	0.085	0.089	0.093		
E	3.20	3.30	3.40	0.126	0.130	0.134		
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е		0.65 bsc.			0.026 bsc.			
К		0.76 ref.			0.030 ref.			
K1		0.41 ref.			0.016 ref.			
L	0.33	0.43	0.53	0.013	0.017	0.021		
Z	0.525 ref.			0.021 ref.				
N: C20-0862-Re /G: 6008	v. B, 20-Jul-2020			·				

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## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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